

REGULATORY COMPLIANCE				
Lead Free COMPLIANT	EU RoHS 2011/65 + 2015/863 COMPLIANT	China RoHS	REACH SVHC COMPLIANT	DRC CONFLICT FREE

ITEM DESCRIPTION

Voltage Controlled Quartz Crystal Clock Oscillators VCXO LVCMOS/TTL (CMOS) 3.3Vdc 6 Pad 5.0mm x 7.0mm Ceramic Surface Mount (SMD)

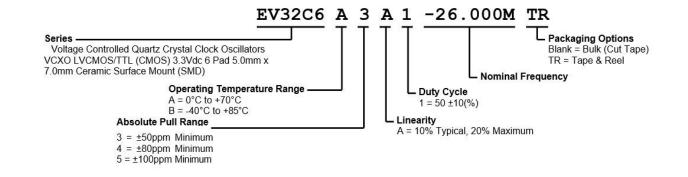
Nominal Frequency	1.544MHz to 77.76MHz	
Frequency Tolerance/Stability	Inclusive of all conditions: Calibration Tolerance at 25°C, Frequency Stability over the Operating Temperature Range, Supply Voltage Change, Output Load Change, Shock, and Vibration. ±50ppm Maximum	
Aging at 25°C	±2ppm/First Year Typical, ±10ppm/10 Years Maximum	
Operating Temperature Range	0°C to +70°C -40°C to +85°C	
Supply Voltage	3.3Vdc ±10%	
Input Current	15mA Maximum	
Output Voltage Logic High (V _{он})	IOH = -4mA 90% of Vdd Minimum	
Output Voltage Logic Low (V _{oL})	IOL = +4mA 10% of Vdd Maximum	
Rise/Fall Time	Measured at 20% to 80% of Waveform 5nSec Maximum	
Duty Cycle	Measured at 50% of Waveform 50 ±10(%)	
Load Drive Capability	10TTL Load or 30pF LVCMOS Load Maximum over Nominal Frequency of 1.544MHz to 12.288MHz 15pF LVCMOS Load Maximum over Nominal Frequency of 12.288001MHz to 77.76MHz	
Output Logic Type	CMOS	
Absolute Pull Range	Inclusive of all conditions: Calibration Tolerance at 25°C, Frequency Stability over the Operating Temperature Range, Supply Voltage Change, Output Load Change, Shock, Vibration, and Aging over the Control Voltage (Vc). ±50ppm Minimum ±80ppm Minimum (Only available over Nominal Frequency range of 1.544MHz to 51.84MHz) ±100ppm Minimum (Only available over Nominal Frequency range of 1.544MHz to 36MHz)	
Control Voltage	Test Condition for APR 0.3Vdc to 3.0Vdc	
Control Voltage Range	0.0Vdc to Vdd	
Linearity	10% Typical, 20% Maximum	
Transfer Function	Positive Transfer Characteristic	
Modulation Bandwidth	Measured at -3dB, Vc = 1.65Vdc 10kHz Minimum	
Input Impedance	50kOhms Minimum	
Input Leakage Current	10μA Maximum	
Phase Noise	All Values are Typical -70dBc/Hz at offset of 10Hz -100dBc/Hz at offset of 100Hz -130dBc/Hz at offset of 1kHz -147dBc/Hz at offset of 10kHz -152dBc/Hz at offset of 100kHz -155dBc/Hz at offset of 1MHz	
Tri-State Input Voltage (Vih and Vil)	90% of Vdd Minimum or No Connect to Enable Output, 10% of Vdd Maximum to Disable Output (High Impedance)	
RMS Phase Jitter	Fj = 12kHz to 20MHz; Random 1pSec Maximum	



 Start Up Time
 10mSec Maximum

 Storage Temperature Range
 -55°C to +125°C

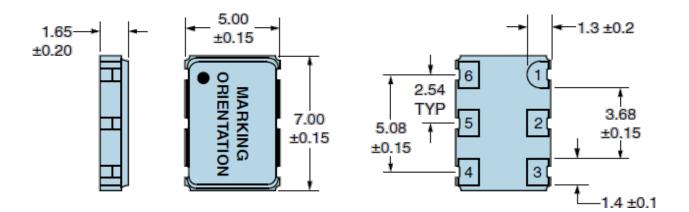
PART NUMBERING GUIDE



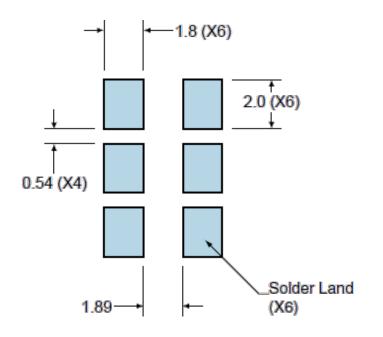
ENVIRONMENTAL & MECHANICAL SPECIFICATIONS			
ESD Susceptibility	MIL-STD-883, Method 3015, Class 1, HBM: 1500V		
Fine Leak Test	MIL-STD-883, Method 1014, Condition A		
Flammability	UL94-V0		
Gross Leak Test	MIL-STD-883, Method 1014, Condition C		
Mechanical Shock	MIL-STD-883, Method 2002, Condition B		
Moisture Resistance	MIL-STD-883, Method 1004		
Moisture Sensitivity	J-STD-020, MSL 1		
Resistance to Soldering Heat	MIL-STD-202, Method 210, Condition K		
Resistance to Solvents	MIL-STD-202, Method 215		
Solderability	MIL-STD-883, Method 2003		
Temperature Cycling	MIL-STD-883, Method 1010, Condition B		
Vibration	MIL-STD-883, Method 2007, Condition A		



MECHANICAL DIMENSIONS



SUGGESTED SOLDER PAD LAYOUT



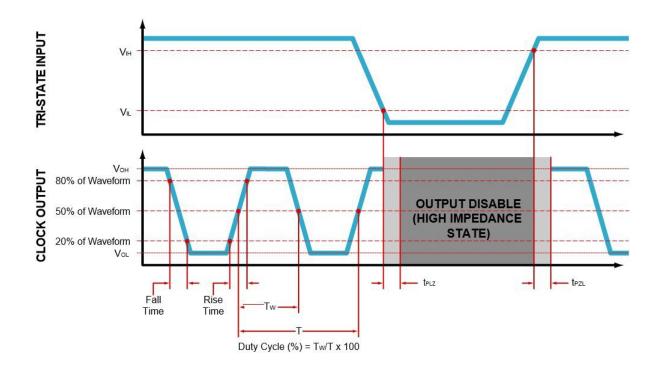
PIN	CONNECTION
1	Control Voltage
2	Tri-State
3	Case Ground
4	Output
5	No Connect
6	Supply Voltage

All Tolerances are ±0.1

All Dimensions in Millimeters

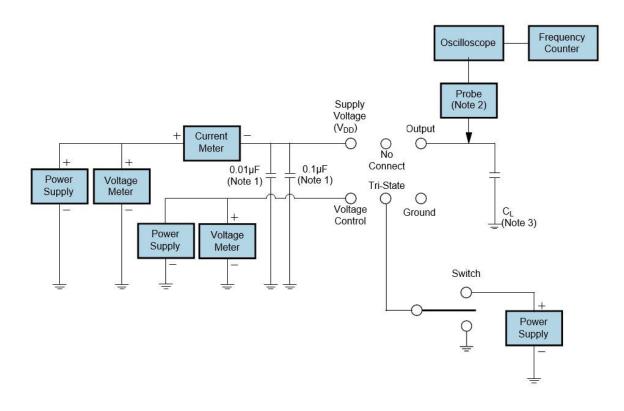


OUTPUT WAVEFORM & TIMING DIAGRAM





TEST CIRCUIT FOR CMOS OUTPUT



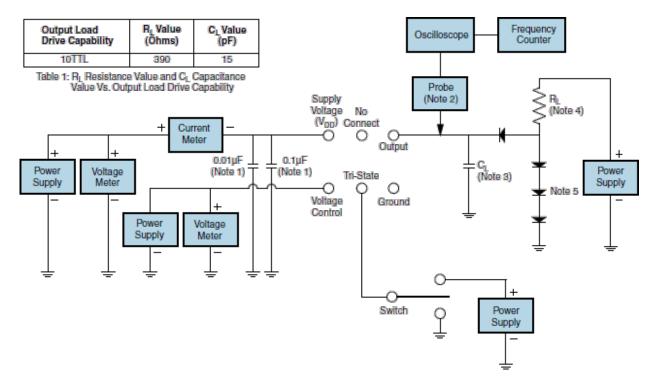
Note 1: An external 0.01µF ceramic bypass capacitor in parallel with a 0.1µF high frequency ceramic bypass capacitor close (less Than 2mm) to the package ground and supply voltage pin is required.

Note 2: A low capacitance (<12pF), 10X attenuation factor, high impedance (>10Mohms), and high bandwidth (>300MHz) passive Probe is recommended.

Note 3: Capacitance value CL includes sum of all probe and fixture capacitance.



TEST CIRCUIT FOR TTL OUTPUT



Note 1: An external 0.01µF ceramic bypass capacitor in parallel with a 0.1µF high frequency ceramic bypass capacitor close (less Than 2mm) to the package ground and supply voltage pin is required.

- Note 2: A low capacitance (<12pF), 10X attenuation factor, high impedance (>10Mohms), and high bandwidth (>300MHz) passive Probe is recommended.
- Note 3: Capacitance value CL includes sum of all probe and fixture capacitance.
- Note 4: Resistance value RL is shown in Table 1. See applicable specification sheet for 'Load Drive Capability'.
- Note 5: All diodes are MMBD7000, MMBD914, or equivalent.

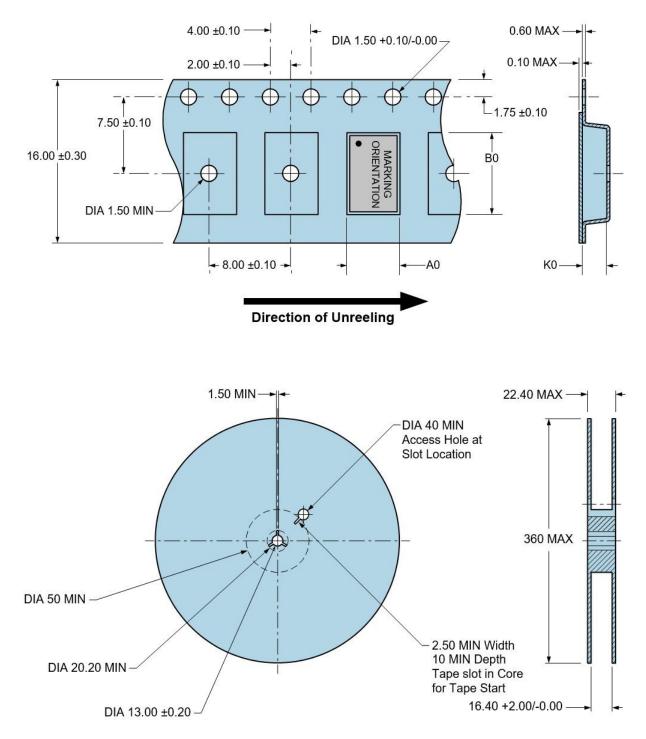


TAPE & REEL DIMENSIONS

Quantity per Reel: 1,000 Units

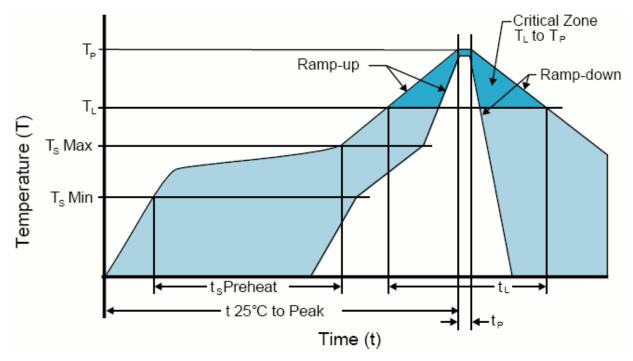
All Dimensions in Millimeters

Compliant to EIA-481





RECOMMENDED SOLDER REFLOW METHOD



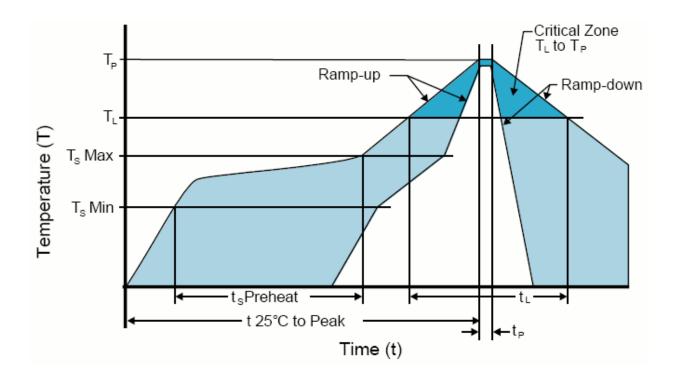
HIGH TEMPERATURE INFRARED/CONVECTION		
T _s MAX to T _L (Ramp-up Rate)	3°C/Second Maximum	
Preheat		
- Temperature Minimum (T _s MIN)	150°C	
 Temperature Typical (T_s TYP) 	175°C	
 Temperature Maximum(T_s MAX) 	200°C	
- Time (t _s MIN)	60 - 180 Seconds	
Ramp-up Rate (T _L to T _P)	3°C/Second Maximum	
Time Maintained Above:		
- Temperature (T∟)	217°C	
- Time (t∟)	60 - 150 Seconds	
Peak Temperature (T _P)	260°C Maximum for 10 Seconds Maximum	
Target Peak Temperature(T _P Target)	250°C +0/-5°C	
Time within 5°C of actual peak (t _p)	20 - 40 Seconds	
Ramp-down Rate	6°C/Second Maximum	
Time 25°C to Peak Temperature (t)	8 Minutes Maximum	
Moisture Sensitivity Level	Level 1	
Additional Notes	Temperatures shown are applied to body of device.	

High Temperature Manual Soldering

260°C Maximum for 5 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)



RECOMMENDED SOLDER REFLOW METHOD



LOW TEMPERATURE INFRARED/CONVECTION		
T _s MAX to T _L (Ramp-up Rate)	5°C/Second Maximum	
Preheat		
- Temperature Minimum (T _s MIN)	N/A	
 Temperature Typical (T_s TYP) 	150°C	
 Temperature Maximum(T_s MAX) 	N/A	
- Time (t _s MIN)	60 - 120 Seconds	
Ramp-up Rate (T∟to T _P)	5°C/Second Maximum	
Time Maintained Above:		
- Temperature (T∟)	150°C	
- Time (t∟)	200 Seconds Maximum	
Peak Temperature (T _P)	240°C Maximum	
Target Peak Temperature(TP Target)	240°C Maximum 2 Times/230°C Maximum 1Time	
Time within 5°C of actual peak (t _P)	10 Seconds Maximum 2 Times / 80 Seconds Maximum 1 Time	
Ramp-down Rate	5°C/Second Maximum	
Time 25°C to Peak Temperature (t)	N/A	
Moisture Sensitivity Level	Level 1	
Additional Notes	Temperatures shown are applied to body of device.	

Low Temperature Manual Soldering

185°C Maximum for 10 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)

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